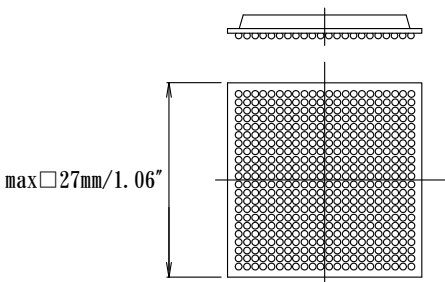


Test & Burn-In Socket, GU66 molded frame series
Size 58x66mm / 2.29x2.60"

- Features:
- High reliability
 - Cost competitive
 - Short delivery time
 - Temperature
-40°C to +150°C
(typical)

● Acceptable device size



max □ 27mm/1.06"

In the case of larger size, consult factory.
Any device on 0.30mm pitch or larger

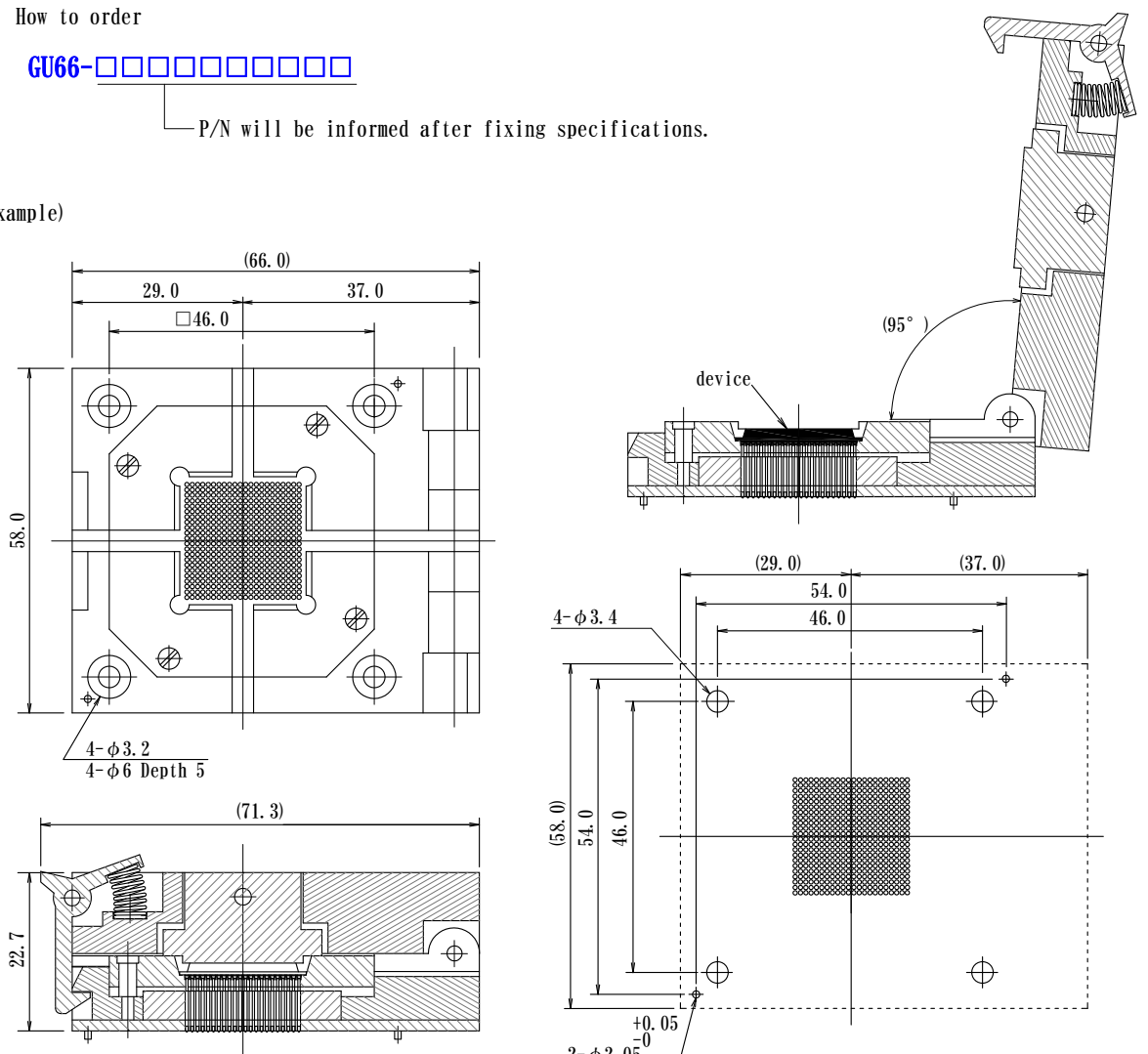


How to order

GU66-□□□□□□□□□□

P/N will be informed after fixing specifications.

example)



Dimensions (mm):

- Overall width: 66.0
- Left section width: 29.0
- Right section width: 37.0
- Device area width: 46.0
- Overall height: 58.0
- Bottom section width: 71.3
- Bottom section height: 22.7
- Device height: 5.4
- Device area height: 46.0
- Pin diameter: 4-φ3.2
- Pin depth: 4-φ6 Depth 5
- Pin diameter (top view): 4-φ3.4
- Pin diameter (bottom view): 2-φ2.05 (+0.05/-0)
- Pin diameter (top view): 54.0
- Pin diameter (top view): 46.0
- Pin diameter (top view): 29.0
- Pin diameter (top view): 37.0
- Pin diameter (top view): 95°

PCB Pattern (Top View)

mm